A+ Server 2123US-TN24R25M (Complete System Only)



Integrated Board



H11DSU-iN

Views: | <u>Angled View</u> | <u>Top View</u> | | <u>Front View</u> | <u>Rear View</u> |

Complete System Only: To maintain quality and integrity, this product is sold only as a completely-assembled system (for optimal performance 16 DIMMs & at least 24/32 cores per CPU is recommended). Minimum requirement is 2 CPUs, 4 DIMMs, 1

NVMe HDD drive.

Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.

Key Features

Virtualization
Cloud Computing
High-End Enterprise Server
Hyperconverged Storage

- 1. Dual AMD EPYC™ 7001/7002* Series Processors (*AMD EPYC 7002 series drop-in support requires board revision 2.x)
- 4TB Registered ECC DDR4 2666MHz SDRAM in 32 DIMMs (7001 Processors)
 8TB Registered ECC DDR4 3200MHz SDRAM in 32 DIMMs (Board revision 2.x required + 7002 Processors)
- 3. Integrated IPMI 2.0 + KVM with dedicated LAN
 - Software Out of Band License key (SFT-OOB-LIC) included for OOB BIOS management
- 4. Dual 25G SFP28 LAN ports
- 5. Drive Bays: 24 hot-swap 2.5" U.2 NVMe drive bays
- 1600W Redundant Power Supplies
 Titanium Level (96%)
 (Full redundancy based on configuration and application load)



Specifications

AS -2123US-	A+ Server 2123US-TN24R25M	Form Factor	■ 2U
TN24R25M		Model	■ CSE-219U2TS-R1K62P
Notherboard		Dimensions and V	Veight
<u>H11DSU-iN</u>		Height	■ 3.5" (89mm)
Processor/Chipset		Width	■ 17.2" (437mm)
СРИ	■ Dual AMD EPYC™ 7001/7002*	Depth	■ 28.46" (723mm)
	series Processors (* Board revision 2.x required) Socket SP3 Supports CPU cTDP up to 280W**	Package	9.96" (H) 24.60" (W) 45.43" (D)
		Weight	Net Weight: 39 lbs (17.7 kg)Gross Weight: 63 lbs (28.6 kg)
Cores	■ Up to 32 Cores (Board revision 1.x +	Front Panel	
	7001 Processors) • Up to 64 Cores (Board revision 2.x + 7002 Processors)	Buttons	Power On/Off buttonSystem Reset button
Chipset	System on Chip (SoC)	LEDs	■ Power LED
Note	** Certain CPUs with high TDP higher than 225W may be supported only under specific conditions. Please contact Supermicro Technical Support for additional information about		 Hard drive activity LED 2x Network activity LEDs System Overheat LED / Fan fail LED / UID LED
	specialized system optimization	Drive Bays	
System Memory Memory	■ 32 DIMM slots	Hot-swap	24 hot-swap 2.5" U.2 NVMe drive bays
Capacity	 Supports up to 4TB Registered ECC DDR4 2666MHz SDRAM (7001 	System Cooling	
	Processors) Supports up to 8TB Registered ECC DDR4 3200MHz SDRAM (Board	Fans	 4 heavy-duty PWM fans with optimal fan speed control
	revision 2.x required + 7002	Air Shroud	■ 1 Air Shroud
	Processors) ■ 8-channel memory bus	Power Supply	
Memory Type	 ■ DDR4 2666 MHz Registered ECC, 288-pin gold-plated DIMMs (7001 Processors) ■ DDR4 3200 MHz Registered ECC, 288-pin gold-plated DIMMs (Board revision 2.x required + 7002 		t Power Supplies with PMBus
		Total Output Power	■ 1600W/1000W
		Dimension (W x H x L)	■ 73.5 x 40 x 203 mm
DIMMA O'	Processors)	Input	 100-127Vac / 13 - 9A / 50-60Hz 200-240Vac / 10 - 8A / 50-60Hz
DIMM Sizes	 4GB, 8GB, 16GB, 32GB, 64GB, 128GB, 256GB* (* Board revision 2.x required + 7002 	+12V	Max: 83.3A / Min: 0A (100-127Vac)Max: 133A / Min: 0A (200-240Vac)
	Processors)	12Vsb	■ Max: 2.1A / Min: 0A
Memory Voltage	■ 1.2V	Output Type	25 Pairs Gold Finger Connector
Error Detection	 Corrects single-bit errors Detects double-bit errors (using ECC memory) 	Certification	Titanium Level [Test Report]
On-Board Devices			
IPMI	■ Support for Intelligent Platform	PC Health Monitoring	
	Management Interface v.2.0 IPMI 2.0 with virtual media over LAN and KVM-over-LAN support ASPEED AST2500 BMC	СРИ	 Monitors CPU Core Voltages, +12V, +3.3V, +5V, +5V standby, 3.3V standby, VBAT CPU switching voltage regulator
Network Connectivity	■ Dual 25GbE SFP28 ports via AOC- 2UR68-M2TS-O (Mellanox ConnectX-4 Lx EN)	FAN	 Up to 4-fan status tachometer monitoring Up to four 4-pin fan headers
VGA	ASPEED AST2500 BMC		 Status monitor for speed control
Expansion Slots			 Pulse Width Modulated (PWM) fan connectors

Input / Output		Temperature	 Monitoring for CPU and chassis environment
NVMe	24 U.2 NVMe support		■ CPU Thermal Trip Support
LAN	■ Dual 25G SFP28 LAN ports ■ 1 RJ45 Dedicated IPMI LAN port		 Thermal control for 4x Fan connectors I²C Temperature Sensing Logic
USB	■ 3 USB 3.0 ports (2 rear + 1 Type A)	LED	■ CPU / System Overheat LED
VGA	2 VGA ports (1 rear, 1 onboard)	Other Features	■ Chassis Intrusion Detection
Others	1 COM port2 SATA DOM power connectorsTPM 2.0 header		Chassis Intrusion Header
		Operating Environment / Compliance	
System BIOS		RoHS	■ RoHS Compliant
BIOS Type	■ AMI 128Mb SPI Flash EEPROM	Environmental Spec.	 Operating Temperature: 10°C to 35°C (50°F to 95°F)
BIOS Features	 Plug and Play (PnP) DMI 2.3 PCI 2.2 ACPI 5.1 USB Keyboard Support SMBIOS 3.1.1 		 Non-operating Temperature: -40°C to 70°C (-40°F to 158°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)

^{*} Please refer to the system manual for more information.

Parts List

Parts List - (Items Included)

	Part Number	Qty	Description	
Motherboard	MBD-H11DSU-iN	1	Super H11DSU-iN Motherboard	
Chassis	CSE-219U2TS-R1K62P	1	2U Chassis	
Add-on Card / Module	AOC-2UR68-M2TS-P	1	2U Ultra 2-port 25G SFP28, 1x PCI-E 3.0 x8 (internal)	
Add-on Card / Module	AOC-SLG3-2E4R-P	2	NVMe AOC by 8,HF,RoHS/REACH	
Add-on Card / Module	AOC-SLG3-4E4R-P	4	NVMe AOC by 16,HF,RoHS/REACH	
Backplane	BPN-NVME3-216N-S4	1	24-port 2U (SC216/219) NVMe direct-attached backplane, support 24x 2.5-inch NVMe devices, 4 of them are hybrid ports also support SAS3/SATA3	
Cable 1	CBL-0088L	4	4 PIN MIDDLE FAN POWER CABLE (PWM). 27cm, 24AWG	
Cable 2	CBL-0174L	2	PWCD,US,NEMA5-15P TO IEC60320 C13,6FT,14AWG,15A,125V,RoHS/REACH	
Cable 3	CBL-0318L	1	CBL,FRONT CNTL,16 TO 16 PIN,RA,RND TUBE,24CM,28AWG	
Cable 4	CBL-PWEX-1018	1	BPN PWR,2X4F/GPU-White to 2x2F,P4.2, 12V, 42CM,18AWG, 11A/pin, -25~85C	
Cable 5	CBL-PWEX-1019	2	BPN PWR,2X4F/GPU-White to 2x2F,P4.2, 12V, 67CM,18AWG, 11A/pin, -25~85C	
Cable 6	CBL-PWEX-1048	1	BPN PWR,2X4F/GPU-White to 2x2F,P4.2, 12V, 82CM,18AWG, 11A/pin, -25~85C	
Cable 7	CBL-SAST-0818	2	OCuLink v. 1.0,INT,PCIe NVMe SSD, 55CM,34AWG	
Cable 8	CBL-SAST-0819	2	OCuLink v 1.0,INT,PCIe NVMe SSD, 65CM,34AWG,RoHS/REACH	
Cable 9	CBL-SAST-0841	8	MiniSAS HD source to OcuLink v 1.0,INT,PCIe, 76CM,34AWG,RoHS	
Cable 10	CBL-SAST-0849	12	MiniSAS HD source to OcuLink v 1.0,INT,PCIe, 57CM,34AWG	
FAN 1	FAN-0158L4	4	80x80x38 mm, 10.5K RPM, Optional Middle Cooling Fan for X10 2U Ultra and HFT Series Servers,RoHS/REACH	
Drive Tray(s)	MCP-220-00121-0B	20	Black gen-3 2.5 NVMe drive tray, Orange tab with lock (improved EMI for hotswap NVMe drive)	
Drive Tray(s)	MCP-220-00121-0B	4	Black gen-3 2.5 NVMe drive tray, Orange tab with lock (improved EMI for hotswap NVMe drive)	
Air Shroud	MCP-310-81905-0B	1	Plastic air shroud for SC819U, 119U, 829U, 219U (PWS),RoHS/REACH	
Power Supply	PWS-1K62A-1R	2	AC-DC 1600W, Titanium Level, Redundancy, 1U, DC Output: +12V and +12Vs, 203 x 73.5 x 40 mm, AC Input: 90 - 264 VAC/47-63Hz, PMBus 1.2 with DSP controller,HF,RoHS/REACH	
Riser Card	RSC-W2-66	1	RSC-W2-66	
Riser Card	RSC-WR-6	1	1U RHS WIO Riser card with one PCI-E 4.0 x16 slot,HF,RoHS	
Heatsink / Retention	SNK-P0063P	2	2U Passive CPU Heat Sink for AMD Socket SP3 Processors	

Optional Parts List

	Part Number	Qty	Description
TPM	AOM-TPM-9655V	-	Vertical TPM with Infineon 9655 TCG 1.2
	AOM-TPM-9665V	-	AOM-TPM-9665V using SLB9665 Chipset supporing TPM2.0,RoHS/REACH
Global Services & Support	OS4HR3/2/1	-	3/2/1-year onsite 24x7x4 service
	OSNBD3/2/1	-	3/2/1-year onsite NBD service
Software	SFT-DCMS-Single	1	DataCenter Management Package (per node license)